DB201 THRU DB207



SINGLE-PHASE GLASS PASSIVATED SILICON BRIDGE RECTIFIER

REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 2.0 AMPERE

FEATURES

· Glass passivated chip junction

· Low forward voltage drop

· High surge overload rating of 50 Amperes peak

· Ideal for printed circuit board

· High temperature soldering guaranteed:

260°C for 10 seconds

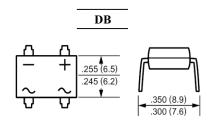
MECHANICAL DATA

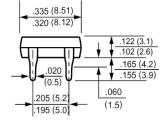
Case: Molded plastic, DB

Epoxy: UL 94V-O rate flame retardant

Terminals: Leads solderable per MIL-STD-202,

method 208 guaranteed Mounting position: Any Weight: 0.02ounce, 0.4gram





Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60H_Z, resistive or inductive load.

For capacitive load, derate current by 20%.

| | Symbols | DB201 | DB202 | DB203 | DB204 | DB205 | DB206 | DB207 | Units | | | | |
|---|-----------------------|--------------|-------|-------|------------|-------|-------|-------|-------|--|--|--|--|
| Maximum Recurrent Peak Reverse Voltage | V _{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | Volts | | | | |
| Maximum RMS Voltage | V _{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | Volts | | | | |
| Maximum DC Blocking Voltage | V _{DC} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | Volts | | | | |
| Maximum Average Forward | Τ, | 2.0 | | | | | | | Amp | | | | |
| Rectified Current at T _A =40℃ | I _(AV) | | | | | | | | | | | | |
| Peak Forward Surge Current, | | | | | | | | | | | | | |
| 8.3ms single half-sine-wave | I _{FSM} | I_{FSM} 60 | | | | | | | Amp | | | | |
| superimposed on rated load (JEDEC method) | | | | | | | | | | | | | |
| Maximum Forward Voltage | V _E | 1.1 | | | | | | | Volts | | | | |
| at 1.0A DC and 25 ℃ | V _F | | | | | | | | | | | | |
| Maximum Reverse Current at T _A =25℃ | т т | 5.0 | | | | | | | uAmp | | | | |
| at Rated DC Blocking Voltage T _A =125℃ | I_R | 500 | | | | | | | | | | | |
| Typical Junction Capacitance (Note 1) | C _J | 25 | | | | | | | pF | | | | |
| Typical Thermal Resistance (Note 2) | $R_{\theta JA}$ | 40 | | | | | | | °C/W | | | | |
| Typical Thermal Resistance (Note 2) | $R_{\theta JL}$ | 15 | | | | | | | °C/W | | | | |
| Operating and Storage Temperature Range | T _J , Tstg | | | | -55 to +15 | 0 | | | ဗ | | | | |

NOTES:

- 1- Measured at 1 MH_Z and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.5 x 0.5" (13 x 13mm) copper pads



RATINGS AND CHARACTERISTIC CURVES

